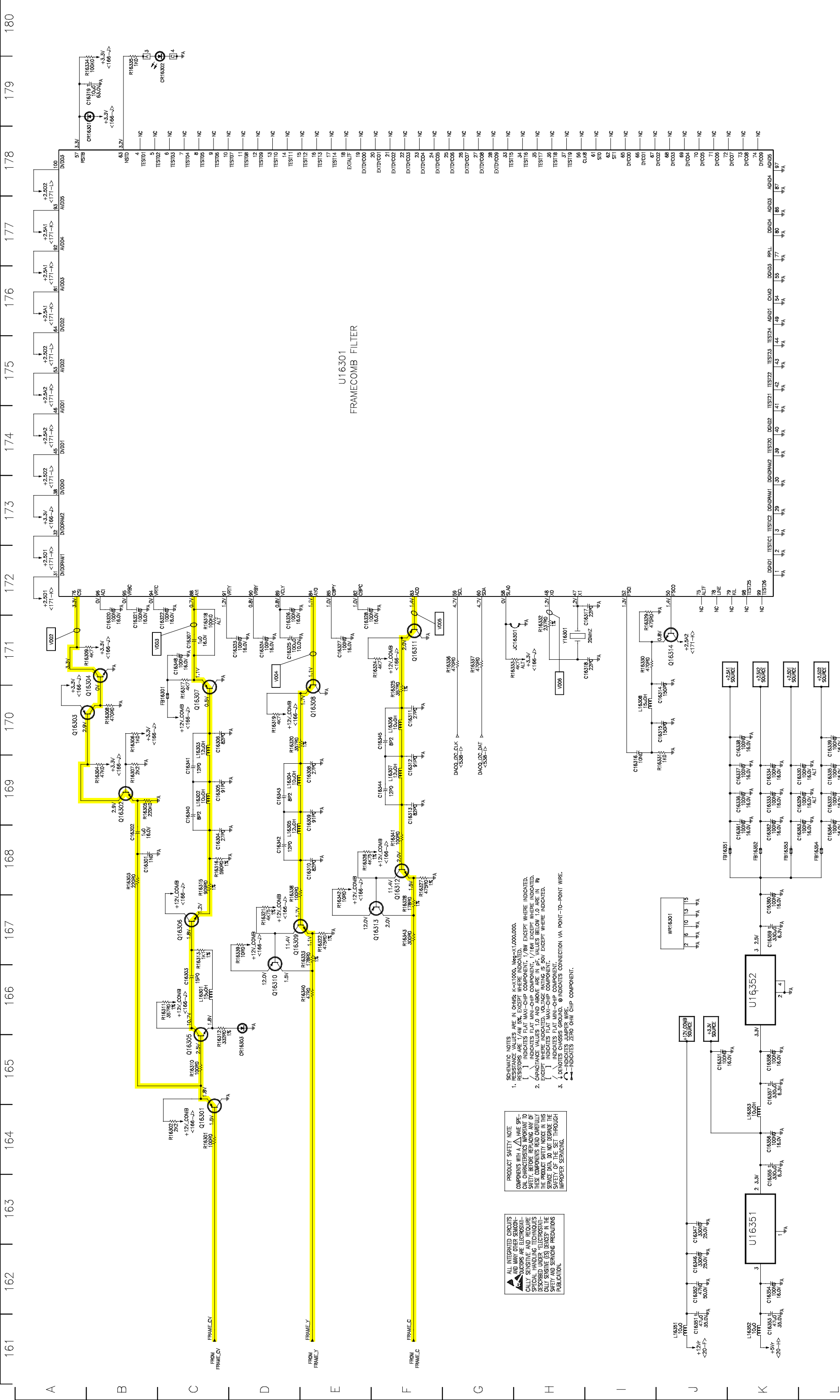


FRAME COMB SCHEMATIC



PRODUCT SAFETY NOTE
ALL INTEGRATED CIRCUITS AND MANY OTHER SEMICONDUCTORS ARE PRECISION-CALIBRATED TO MEET THE SPECIFICATIONS OF THE PRODUCT. THESE COMPONENTS MUST BE HANDLED CAREFULLY TO AVOID DAMAGE TO THE SAFETY OF THE SET THROUGH IMPROPER SERVICING.

1. RESISTORS ARE IN OHMS, K=1000, M=1,000,000.
RESISTORS ARE 1/4W 5% EXCEPT WHERE INDICATED.
1 INDICATES FLAT MAXI-CHIP COMPONENT, 1/8W EXCEPT WHERE INDICATED.
2 INDICATES FLAT MINI-CHIP COMPONENT, 1/16W EXCEPT WHERE INDICATED.
CAPACITANCE VALUES 1.0 AND ABOVE ARE IN pF, VALUES BELOW 1.0 ARE IN pF EXCEPT WHERE INDICATED.
3 INDICATES FLAT MAXI-CHIP COMPONENT.
4 INDICATES FLAT MINI-CHIP COMPONENT.
5 DENOTES CHASSIS GROUND. 6 INDICATES CONNECTION VIA POINT-TO-POINT WIRE.
7 INDICATES JUMPER WIRE.
8 INDICATES ZERO OHM CHIP COMPONENT.